

### ADVANTAGES

- Suitable for applications with or without cable such as USB chargers
- Can meet USB OMTP undershoot requirement
- < 30 mW no-load power consumption (5\* rating)
- Low cost bipolar primary switch
- Tight tolerance CV/CC operation
- Low component count
- High efficiency (Energy Star 2.0 compliance with margin)
- Programmable maximum switching frequency



### FEATURES

- Advanced primary sensing controller achieves true CV/CC output characteristic without opto-coupler
- Full featured protection for over-temperature, input over-voltage, input under-voltage, output short-circuit
- Advanced PFM/PWM control and quasi-resonant switching for increased efficiency
- Switching timing jitter spreads RF spectral emissions, eases EMC compliance
- SOT23-6 package

### APPLICATIONS

USB chargers; for mobile phones, digital camera and MP3 players.

Universal standby and auxiliary power supplies up to 8 W using C2162DX2 (up to 4 W using C2161DX2).

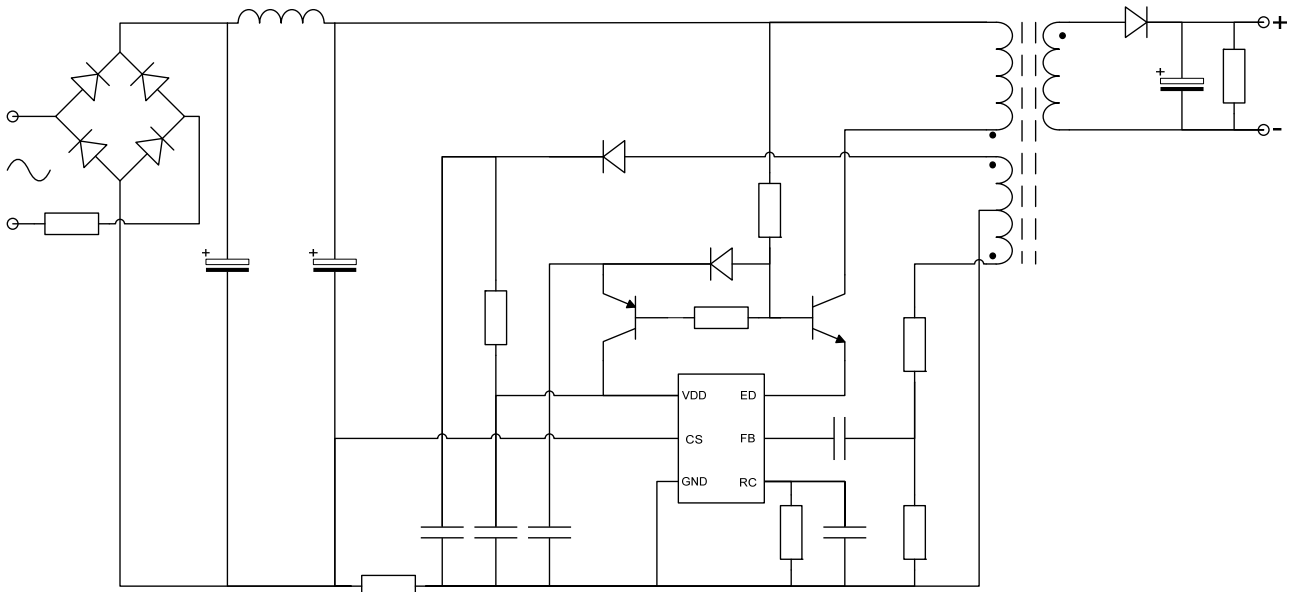


Figure 1: Typical Application Circuit

### BLOCK DIAGRAM

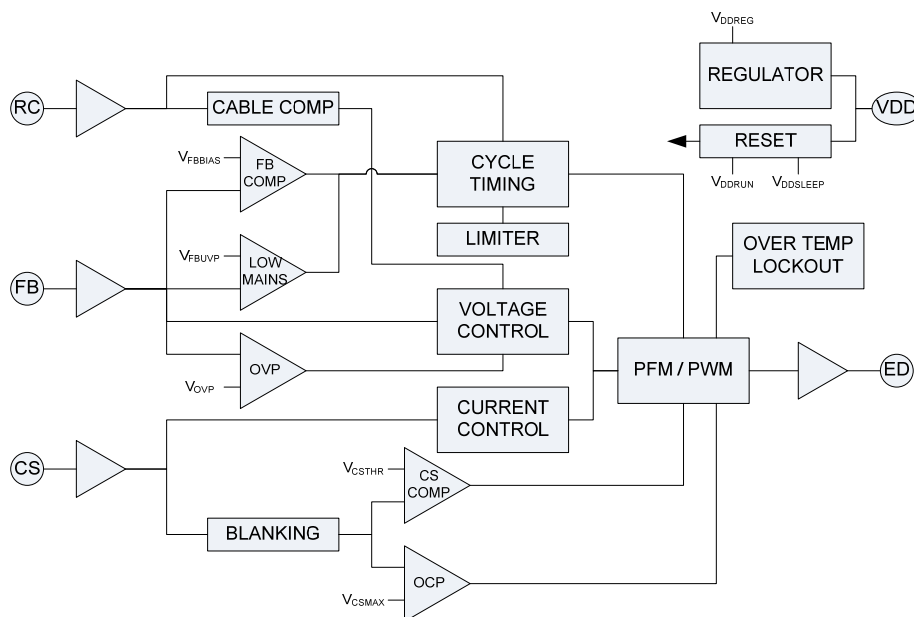


Figure 2: C2161DX2 and C2162DX2 Block Diagram

### PIN DEFINITIONS

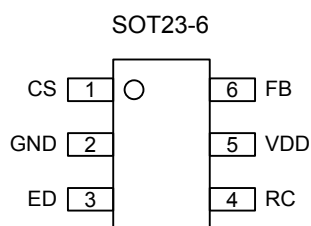


Figure 3: C2161DX2 and C2162DX2 Pin Assignment

#### VDD Pin

The VDD pin supplies power to the chip and dictates the operating mode (Run or Sleep).

#### FB Pin

The FB pin is used to sense the transformer winding voltage waveform, scaled and AC-coupled by an external RC network (Rfb1, Rfb2 and Cfb in Figure 4).

#### CS Pin

The CS pin senses the primary switch current via the current sensing resistor (Rcs in Figure 4).

#### RC Pin

The RC timing network connected to the RC pin (shown as Rosc, Cosc in Figure 4) defines both the required maximum switching frequency  $F_{MAX}$  and the cable compensation.

#### ED Pin

The ED pin is connected to the emitter of the external bipolar junction transistor (Q1 in Figure 4).

#### GND Pin

The GND pin provides the ground reference.

### TYPICAL APPLICATION

The C2161DX2 and C2162DX2 controllers are intended primarily for 5 V USB chargers meeting the 5-star energy saving requirements, but are equally applicable to other off-line applications up to 8 W requiring low standby power and high efficiency. A high degree of configurability allows a wide range of applications to be met at minimum cost. A typical application circuit is shown in Figure 4.

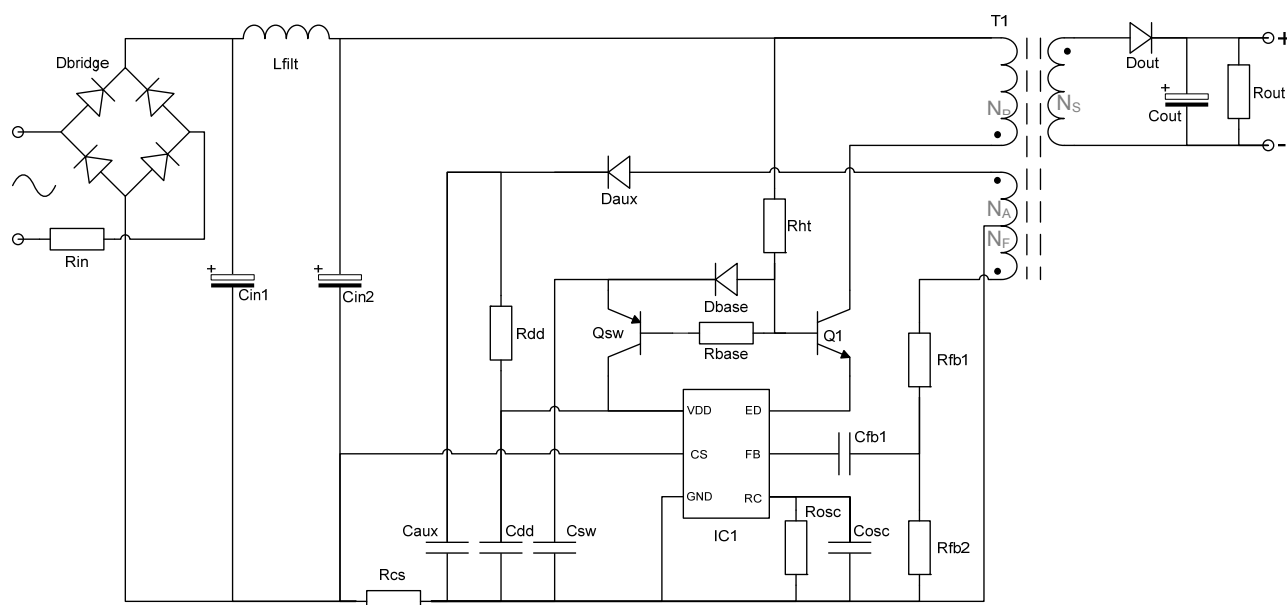


Figure 4: Universal Input 4 W Charger

### Typical 4 W Charger Performance

Input	V <sub>IN</sub>	85 - 265 V ac
Output	V <sub>OUTNOM</sub>	5 V dc (± 5%)
	I <sub>OUTNOM</sub>	800 mA dc (-0/+10%)
Cable compensation	G <sub>CAB</sub>	1 %
Average Typical Efficiency (including cable)	K <sub>EFF</sub>	> 70%
No-load input power consumption	P <sub>INSTBY</sub>	< 30 mW
Over-temperature protection (OTP)	T <sub>SH</sub>	115 °C
Start-up time	t <sub>START</sub>	< 1 s

### PRINCIPLE OF OPERATION

Parameters used in equations are explained in the Electrical Characteristics section.

#### Power-Up/Power-Down Sequences

The C2161DX2 and C2162DX2 controllers are powered via the VDD pin. When the line input is first applied, a small amount of current ( $I_{DD\text{SLEEP}}$ ) is drawn from the rectified mains input via a high value start up resistor ( $R_{ht}$  in Figure 4). When the voltage on the VDD pin ( $V_{DD}$ ) reaches a level  $V_{DD\text{RUN}}$  the controller wakes up, demands more supply current ( $I_{DD\text{REG}}$ ) and enters the Initialise mode (see Figure 5). The controller stays in Initialise for a short time during which internal circuits are enabled and then changes to Run mode. In Run mode, the controller uses an internal shunt regulator to regulate  $V_{DD}$  at  $V_{DD\text{REG}}$ .

If the VDD pin voltage drops  $\Delta V_{DD\text{SLEEP}}$  below  $V_{DD\text{REG}}$  the controller goes back into Sleep mode, reducing the supply current demand. The system will restart when input power is restored and  $V_{DD}$  reaches  $V_{DD\text{RUN}}$  again. To achieve a smooth power up sequence the VDD reservoir capacitor ( $C_{dd}$  in Figure 4) needs to be large enough to sustain the supply over the Initialise period and the first few cycles of Run mode, until the auxiliary rail voltage supply is established.

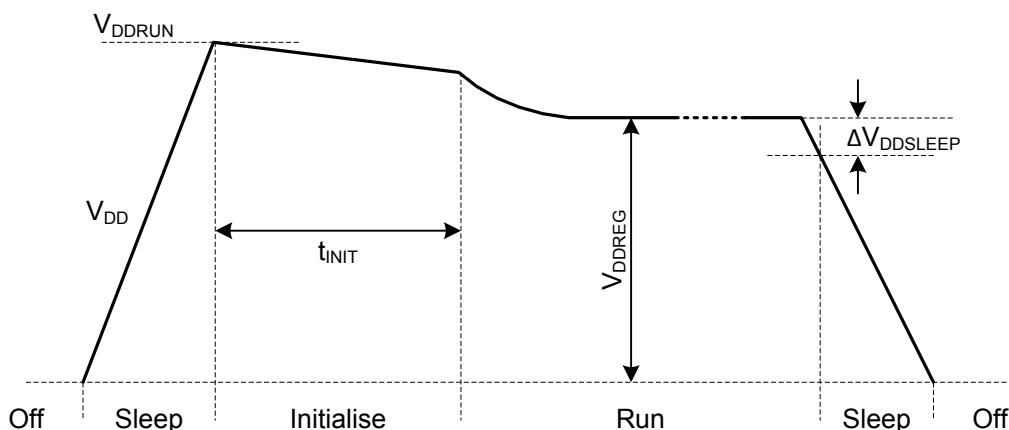


Figure 5: VDD Pin Waveform ( $V_{DD}$ )

Mode	Description
Sleep	From initial application of power or from Run mode if $V_{DD}$ falls below $\Delta V_{DD\text{SLEEP}}$ below $V_{DD\text{REG}}$ , the controller changes to Sleep mode. Non-essential controller circuits are powered down and the external switching transistor (Q1) is held off. Exit from Sleep mode occurs when $V_{DD}$ rises above $V_{DD\text{RUN}}$ and the controller moves to the Initialise mode.
Initialise	When Initialise mode is entered, internal controller circuits are initialised and two clock cycles are issued, after which the controller changes from Initialise to Run mode.
Run	Converter operation continues. The shunt regulator controls $V_{DD}$ to $V_{DD\text{REG}}$ . If $V_{DD}$ falls $\Delta V_{DD\text{SLEEP}}$ below $V_{DD\text{REG}}$ , the controller ceases power conversion and reverts to Sleep mode.

Table 1: Summary of Controller Modes



### Constant Voltage and Constant Current (CV/CC) Operation

The C2161DX2 and C2162DX2 controllers achieve constant voltage and constant current output within tight limits without the need for any secondary sensing components, by sensing the primary side waveforms of transformer voltage and primary switch current. Figure 6 shows the output characteristics of a typical phone charger implemented with the C2161DX2 and C2162DX2.

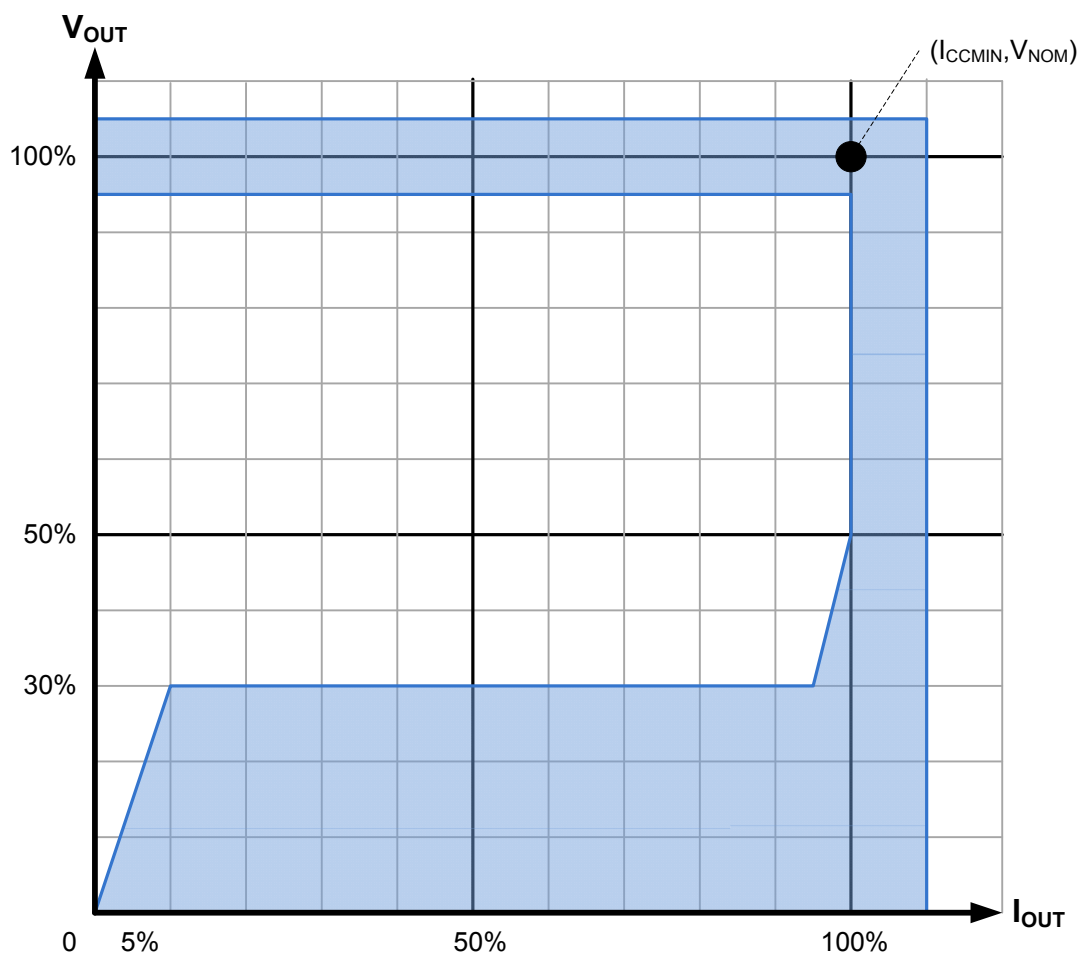


Figure 6: Achievable Charger Output Characteristic Using C2161DX2 and C2162DX2

### Switching Waveforms

Typical switching waveforms for the FB, CS and RC inputs are shown with the ED output in Figure 7.

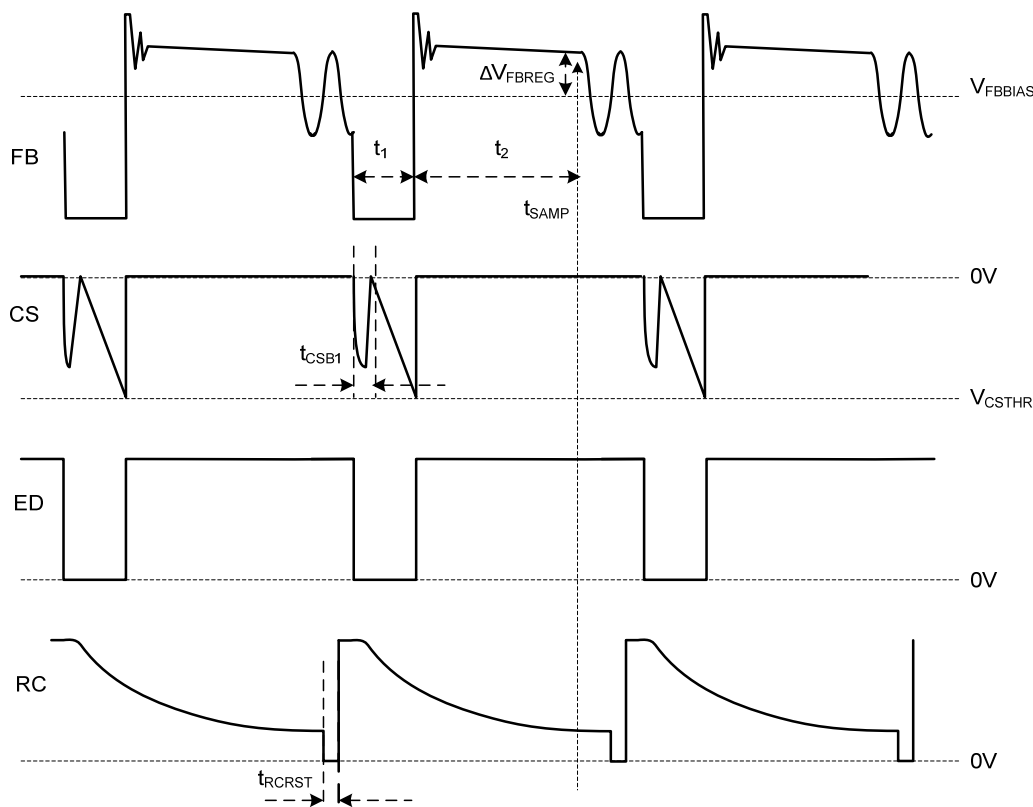


Figure 7: Typical Waveforms: ED, FB, CS, RC pins

### Constant Voltage (CV) Regulation

Constant voltage regulation is achieved by sensing the FB input, which is AC coupled to the auxiliary winding of the transformer, as shown in Figure 4. The FB pin is internally biased to  $V_{FBBIAS}$ . A typical voltage waveform seen on this pin is shown in Figure 7.

The waveform is analysed and sampled at  $t_{SAMP}$  to derive an estimate of the reflected output voltage. The  $t_{SAMP}$  point is identified by the change in slope of the transformer auxiliary winding waveform (as sensed by the FB input) immediately prior to the zero crossing. The difference between the sampled voltage and the FB regulation voltage ( $\Delta V_{FBREG}$ ) is used to derive the system power demand and close the voltage control loop.

The regulated output voltage is determined by the selection of the potential divider resistors ( $R_{fb1}$ ,  $R_{fb2}$  in Figure 4) and the chosen transformer turns ratio. The total parallel combination of these resistors should be typically less than  $120\ \Omega$  to prevent unwanted effects of stray capacitance. The tolerances of  $R_{fb1}$  and  $R_{fb2}$  affect output voltage regulation and would typically be chosen to be 1% or better. Values of  $R_{fb1}$ ,  $R_{fb2}$  and  $C_{fb}$  are given by the equations:

$$R_{fb2} = 120\ \Omega$$

$$C_{fb} = 47\text{nF} \pm 20\%$$

$$R_{fb1} = \frac{R_{fb2} \left( V_{OUTNOM} \frac{N_F}{N_S} - \Delta V_{FBREG} \right)}{\Delta V_{FBREG}}$$

### Constant Current (CC) Regulation

The current flowing through the transformer primary winding is sensed on the CS pin by the voltage generated across the current sensing resistor ( $R_{CS}$  in Figure 4). The voltage seen on the CS pin is a negative-going voltage waveform as shown in Figure 7. When the voltage on the CS pin exceeds a (negative) threshold  $V_{CSTHR}$ , the primary switching transistor is rapidly turned off. The internal loop controller regulates the CS voltage threshold ( $V_{CSTHR}$  in Figure 7) between  $V_{CSMIN}$  and  $V_{CSMAX}$ , based on the average CS input voltage and CC regulation set point ( $V_{CSCC}$ ) to achieve constant output current regulation. Blanking is provided for a period of  $t_{CSB1}$  to prevent false triggering due to leading edge spikes in the waveform.

Constant Current regulation is determined by the transformer turns ratio and the value of  $R_{CS}$ . The value of  $R_{CS}$  is determined by the required output current ( $I_{OUT}$ ) and transformer primary-secondary turns ratio ( $N_P/N_S$ ) according to the approximation:

$$R_{CS} \approx \left( \frac{N_P}{N_S} \right) \left( \frac{V_{CSCC}}{I_{OUT}} \right)$$

The tolerance of  $R_{CS}$  has a direct relationship to the accuracy of the output current limit and is typically chosen to be 1%.

### Cable Drop Compensation

The C2161DX2 and C2162DX2 controllers adjust the output voltage of the power supply to compensate for the voltage drop seen in the output cable. However, the benefit of this IC is that it can minimize cable compensation to 1% suitable for USB applications. The amount of compensation applied ( $G_{CAB}$ ) is programmed by the value of the capacitor connected to the RC pin, ( $C_{OSC}$  in Figure 4) according to the equation:

$$C_{OSC} = \frac{K_{CAB}}{G_{CAB}}$$

### Drive Pulse and Frequency Modulation

The C2161DX2 and C2162DX2 control both the primary switch peak current and the switching frequency in response to the power demanded by the application load. The controller ensures that power conversion is performed in discontinuous conduction mode (DCM) at all times. The switching frequency is varied depending on the actual power demand. The maximum switching frequency is set by  $F_{MAX}$ . The C2161DX2 and C2162DX2 controllers do not have a minimum switching frequency. The full-load frequency  $F_{MAX}$  (chosen in the range 40 to 66 kHz) is set by the equations:

$$F_{MAX} = \frac{1}{K_{OSC} \cdot \tau_{RCOSC} + t_{RCRST}}$$

The oscillator time constant  $\tau_{RCOSC}$  is controlled by external components  $C_{OSC}$ ,  $R_{OSC}$  so that:

$$\tau_{RCOSC} = R_{OSC} \cdot C_{OSC}$$

### Duty Cycle Control

The maximum duty cycle is set by the primary-secondary turns ratio ( $N_P/N_S$ ) of the transformer (typically 16:1 for a 5 V output). For a typical universal input offline application, a maximum duty cycle of 50% is chosen for the minimum rectified supply voltage (typically 80  $V_{DC}$ ).

### Soft Switching

Zero current (quasi-resonant) switching is used to minimise the switching losses in the primary switch, thereby increasing efficiency and introducing frequency jitter, to spread the RF emissions spectrum. The primary switching BJT is turned on when the voltage across it is a minimum (as detected by the FB input), minimising the capacitive switching losses and reducing the RF emissions.

### Cascode Switching

The primary switch is connected in cascode configuration to ensure fast and efficient switching using low-cost bipolar transistors, e.g. MJE13002, STX13003, STBV42, STBV45, TS13003MV. The slew rate of the ED drive pin is limited to minimise conducted and radiated EMI.

### Fast Load Step Response

When a drop in output voltage is detected due to a large load step from no-load, the controller quickly ramps up output power. This prevents the output voltage from dropping further, as shown in Figure 8. The total voltage drop is determined by the application circuit and the no-load switching frequency ( $f_{NLP}$ ).

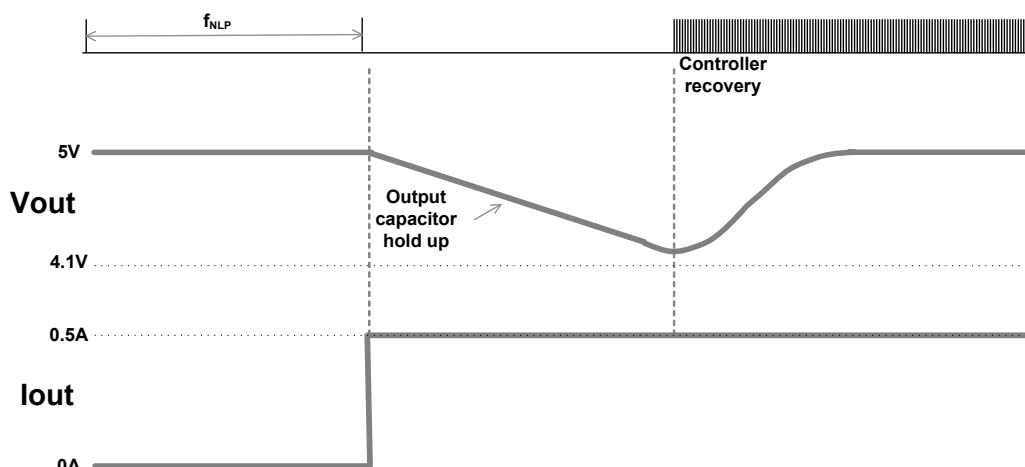


Figure 8: No-load to 0.5 A Load Step Recovery

### Protection Features

#### Short-Circuit Protection

If required, the application circuit can be forced to hiccup if the output is short-circuit. This is achieved by designing the auxiliary winding on the transformer (T1) so that the auxiliary rail voltage (at the cathode of Daux) is too low, allowing the VDD pin to fall by at least  $\Delta V_{DDSLP}$  below  $V_{DDREG}$ . The controller will repeatedly switch between Sleep and Run modes, resulting in low power consumption. (When the short-circuit condition is removed, the application returns to normal operation.)

#### Mains Under Voltage Protection (UVP) and Over Voltage Protection (OVP)

The regulated output voltage is reduced when the rectified input voltage falls outside the normal working voltage range, defined by  $V_{UVP}$  and  $V_{OVP}$ . The value is defined by the nominal output voltage ( $V_{OUTNOM}$ ), the primary-secondary turns ratio ( $N_P/N_S$ ) and other IC parameters by the equation:

$$V_{UVP} \approx V_{OUTNOM} \frac{N_P}{N_S} \frac{|\Delta V_{FBUVP}|}{\Delta V_{FBREG}} \quad V_{OVP} \approx V_{OUTNOM} \frac{N_P}{N_S} \frac{V_{FBBIAS}}{\Delta V_{FBREG}}$$

**Over Temperature Protection (OTP)**

The on-chip OTP is triggered if the junction temperature exceeds the threshold  $T_{SH}$ , shutting down the controller. To prevent possible damage to the PCB, the OTP prevents restarting until the temperature has dropped to  $(T_{SH} - T_{SHHYST})$ .

**Primary Switch Over Current Protection (OCP)**

The primary switch is turned off if the primary switch current exceeds a preset threshold  $V_{CSMAX}$ , as sensed by the CS input, subject to the minimum on-time  $T_{ONMIN}$ . This gives pulse by pulse over current protection.

**Output Over Voltage Protection**

The switching operation is inhibited when the output voltage is above the nominal range, defined by  $V_{OUTOVP}$ . The value is defined by the nominal output voltage ( $V_{OUTNOM}$ ) and the feedback OVP to regulation level ratio:

$$V_{OUTOVP} = V_{OUTNOM} \cdot G_{FBOVP}$$

### ABSOLUTE MAXIMUM RATINGS

CAUTION: Permanent damage may result if a device is subjected to operating conditions at or in excess of absolute maximum ratings.

Parameter	Symbol	Condition	Min	Max	Unit
Supply voltage	$V_{DD}$		-0.5	4.5	V
Supply current	$I_{DD}$		-20	90	mA
FB input voltage	$V_{FB}$	DC condition	-0.5	$V_{DD} + 0.5$	V
CS input voltage	$V_{CS}$		-0.5	$V_{DD} + 0.5$	V
RC input voltage	$V_{RC}$		-0.5	$V_{DD} + 0.5$	V
ED pin voltage	$V_{ED}$		-0.5	$V_{DD} + 0.5$	V
FB input current	$I_{FB}$		-20	20	mA
CS input current	$I_{CS}$		-20	20	mA
RC input current	$I_{RC}$		-35	250	mA
ED pin current	$I_{ED}$	C2161DX2	-20	400	mA
		C2162DX2	-20	650	mA
Junction temperature	$T_J$		-25	125	°C
Storage temperature	$T_P$		-40	150	°C
Lead temperature	$T_L$	Soldering, 10 s		260	°C
ESD withstand		Human body model, JESD22-A114		2	kV
		Charged device Model, ANSI-ESD-STM5.3.1		500	V

### NORMAL OPERATING CONDITIONS

Unless otherwise stated, electrical characteristics are defined over the range of normal operating conditions. Functionality and performance is not defined when a device is subjected to conditions outside this range and device reliability may be compromised.

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Supply voltage	$V_{DD}$		3.1	3.45	3.6	V
Supply current	$I_{DD}$				30	mA
Full power switching frequency	$F_{NOM}$	Full-load, application dependent	36	40	66	kHz
Transformer resonance frequency (in-circuit)	$F_{RES}$		300			kHz
Junction temperature	$T_J$		-25	25	105	°C

### ELECTRICAL CHARACTERISTICS

Unless otherwise stated:

1. Min and Max electrical characteristics apply over normal operating conditions.
2. Typical electrical characteristics apply at  $T_J = T_{J(TYP)}$  and  $I_{DD} = I_{DDREG(TYP)}$ .
3. The chip is operating in Run mode.
4. Voltages are specified relative to the GND pin.

#### VDD Pin

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Supply voltage	$V_{DDRUN}$	To enter Initialise mode	3.6	4.0	4.45	V
	$V_{DDREG}$	In Run mode	3.3	3.45	3.6	V
	$\Delta V_{DDSLP}$	To enter Sleep mode (measured relative to $V_{DDREG}$ )		-600		mV
Supply current	$I_{DDREG}$	In Run mode			2.4	mA
	$I_{DDSLP}$	In Sleep mode			5.5	$\mu$ A
Initialisation time	$t_{INIT}$			$3\tau_{RCOSC}$		s

#### FB Pin

Parameter	Symbol	Condition	Min	Typ	Max	Unit
FB bias voltage	$V_{FBBIAS}$	Internal DC bias voltage	1.66		1.84	V
FB regulation level	$\Delta V_{FBREG}$	Measured relative to $V_{FBBIAS}$ $T=25^\circ\text{C}$	394.5	405	415.5	mV
FB slope detection threshold	$\Delta V_{FB}/\Delta t$		-280	-200	-120	mV/ $\mu$ s
FB input resistance	$R_{FBIN}$	Effective input resistance $0 < V_{FB} < V_{DD}$		50		k $\Omega$
FB initialisation current	$I_{FBINIT}$	$V_{FB} = 0 \text{ V}$		-1.8		mA
FB OVP ratio	$G_{FBOVP}$	Measured relative to $V_{FBBIAS}$	1.4		1.8	
FB UVP comparator threshold offset	$\Delta V_{FBVUP}$			-135		mV

#### RC Pin

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Maximum switching frequency	$F_{MAX}$	$220 \text{ pF} < C_{osc} < 2.2 \text{ nF}$	30		66	kHz
Maximum frequency control factor	$K_{OSC}$			0.31		
Cable compensation	$G_{CAB}$		1		10	%
Cable compensation factor	$K_{CAB}$			20		pF
Oscillator reset time	$t_{RCRST}$			2.7	3.8	$\mu$ s

### CS Pin

Parameter	Symbol	Condition	Min	Typ	Max	Unit
CS input minimum threshold	$V_{CSMIN}$	Outside CS blanking time $t_{CSB1}$	Minimum load	-38		mV
CS input maximum threshold	$V_{CSMAX}$		Over-current protection	-182		mV
CS turn-off response time	$t_{CSOFF}$		Step $\Delta V_{CS}$ : $V_{CSMAX} + 10\text{ mV}$ to $V_{CSMAX} - 10\text{ mV}$	175		ns
CS Input Offset	$\Delta V_{CSOFF}$			0		$\mu\text{V}$
CS Input Leakage Current	$I_{CSLEAK}$	$-0.2\text{ V} < V_{CS} < V_{DD}$	-10		10	$\mu\text{A}$
CS input limit for CC operation (average)	$V_{CSCC}$	$F = 40\text{ kHz}$ , $t_1 = t_2 = 12.5\text{ }\mu\text{s}$ , $T = 25^\circ\text{C}$	-32.5	-31.4	-30.3	mV
Leading edge blanking time	$t_{CSB1}$	See Figure 7		400		ns

### ED Pin

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On-state resistance	$R_{EDON}$	$I_{ED} < I_{ED(MAX)}$		0.9	1.25	$\Omega$
Off-state current	$I_{EDOFF}$	$V_{ED} = V_{DD}$			10	$\mu\text{A}$
Minimum on-time	$t_{ONMIN}$			575		ns



### THERMAL CIRCUIT PROTECTION

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Thermal shutdown temperature	$T_{SH}$	At silicon junction	105	115	125	°C
Thermal shutdown hysteresis	$T_{SHHYST}$	At silicon junction		30		°C

### PACKAGE THERMAL RESISTANCE CHARACTERISTICS

Conditions:

1. Controller IC mounted on typical PCB (1.6 mm thick, 35  $\mu$ m copper, CEM1);
2.  $\theta_{JB}$  measured to pin terminal of device at the surface of the PCB.

Package	Junction-to-board $\theta_{JB}$ (Typical)	Junction-to-ambient $\theta_{JA}$ (Typical)	Units
SOT23-6	60	170	°C / W

### PACKAGING AND ORDERING INFORMATION

#### Package Marking

The SOT23-6 package is marked with a short code indicating type and production lot as shown in Figure 9.

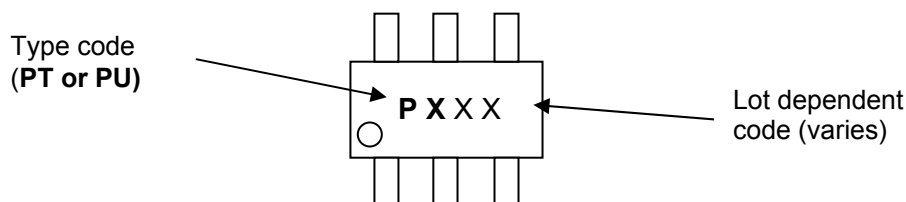


Figure 9: SOT23-6 Package Marking

#### Ordering

Type	Package	Marking	Packing Form	Shipping
C2162DX2	SOT23-6	PUxx	7" Tape & Reel	C2162DX2-TR7
			13" Tape & Reel	C2162DX2-TR13
C2161DX2	SOT23-6	PTxx	7" Tape & Reel	C2161DX2-TR7
			13" Tape & Reel	C2161DX2-TR13

For further package and ordering information, please contact CamSemi.

## DATASHEET STATUS

The status of this Datasheet is shown in the footer. Always refer to the most current version.

Datasheet Status	Product Status	Definition
Product preview	In development	The Datasheet contains target specifications relating to design and development of the described IC product. Application circuits are illustrative only. Specifications are subject to change without notice.
Preliminary	In qualification	The Datasheet contains preliminary specifications relating to functionality and performance of the described IC product. Application circuits are illustrative only. Specifications are subject to change without notice.
Product data	In production	The Datasheet contains specifications relating to functionality and performance of the described IC product which are supported by testing during development and production. Application circuits are illustrative only. Specifications are subject to change without notice.

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